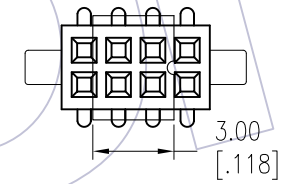
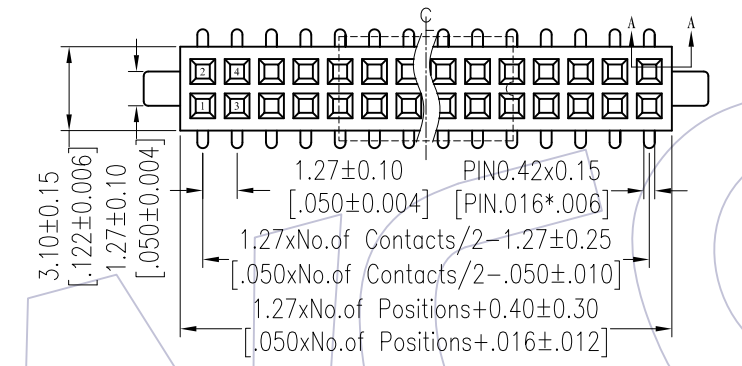
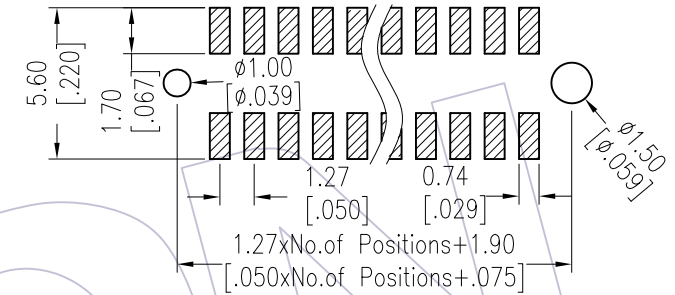


# HSF

Recommended P.C.B Layout(Top Side)  
(PCB BOARD TOLERANCE±0.05)

NOTES:  
Current Rating:1.0AMP  
Contact Resistance:20mΩ Max  
Withstand Voltage:500V AC/DC  
Insulation Resistance:1000MΩ Min  
Operation Temperature:-40℃ to +105℃

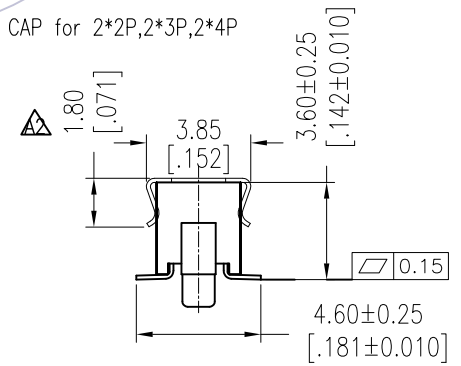
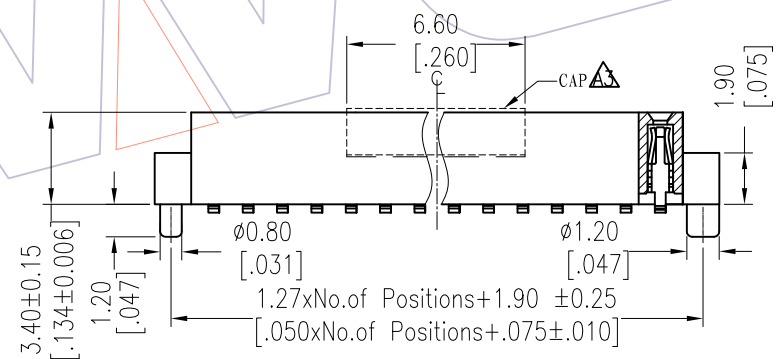
Contact Material:Phosphor Bronze  
Contact plating:Au over Ni  
Insulator Material:PA9T+30%GF UL94V-0



## Ordering Information

2334-2 XX M XX CUN X 3

No. of Pins per Row: 02-50Pin  
Contact Plating:  
G0=Gold Flash  
G3=10u"Gold  
G4=15u"Gold  
G5=30u"Gold  
Packing:  
T=Tube  
P=Tube+CAP  
R=Tape&Reel+CAP



Item	Pitch	Mating
Standard	1.27	1310/1315/1320/3131
Alternate		

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	DIM	TOL	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
A3	2014/12/30	Modify CAP	-----	x.X	±0.40	OPERATION	wang	2014/12/30	UNIT	mm	2334-2XXMXXCUNX3
A2	2013/08/21	Modify cap2.00→1.80	-----	x.XX	±0.25	CHECK			SIZE	A4	TITLE:
A1	2013/07/01	Modify drawing	-----	x.XXX	±0.15	APPROVE			SHEET	1/1	FH1.27mm DUAL ROW 180° SMT WITH DIFFERENT POST AND METAL CAP H=3.40
A0	2012/07/06	NEW	-----	Angle	± 3'				PROJ.		Customer NO.

# WCON

Http: www.wcon.com

WCON-Dongguan  
Tel: +86 769 85358920  
Fax: +86 769 85358915  
E-mail: sales@wcon.com

WCON-Kunshan  
Tel: +86 512 57468408  
Fax: +86 512 57468468  
E-mail: salesks@wcon.com